

## Product Summary

| Device | BV <sub>DSS</sub> | R <sub>DS(ON)</sub> Max      | I <sub>D</sub> Max<br>T <sub>A</sub> = +25°C |
|--------|-------------------|------------------------------|--|
| Q1     | 60V               | 1.7Ω @ V <sub>GS</sub> = 10V | 571mA  |
|        |                   | 3Ω @ V <sub>GS</sub> = 4.5V  | 430mA  |
| Q2     | -50V              | 6Ω @ V <sub>GS</sub> = -10V  | -304mA                                       |
|        |                   | 8Ω @ V <sub>GS</sub> = -5V   | -263mA                                       |

## Features and Benefits

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Ultra-Small Surface Mount Package
- **ESD Protected Gate**
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**
- **PPAP Capable (Note 4)**

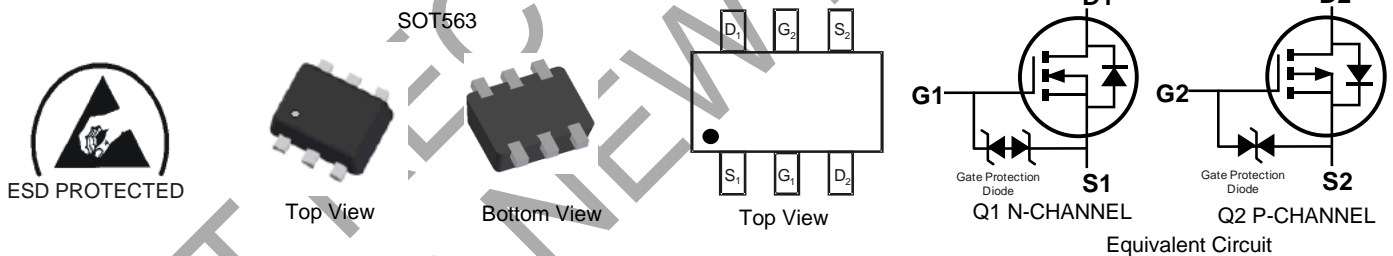
## Description and Applications

This MOSFET is designed to meet the stringent requirements of Automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

- Power Management Functions
- DC-DC Converters
- Battery

## Mechanical Data

- Case: SOT563
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish – Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 <sup>(e3)</sup>
- Weight: 0.003 grams (Approximate)

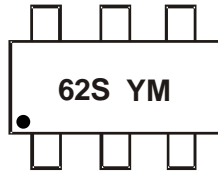


## Ordering Information (Note 5)

| Part Number   | Case   | Packaging          |
|---------------|--------|--------------------|
| DMC62D0SVQ-7  | SOT563 | 3,000/Tape & Reel  |
| DMC62D0SVQ-13 | SOT563 | 10,000/Tape & Reel |

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
  2. See [http://www.diodes.com/quality/lead\\_free.html](http://www.diodes.com/quality/lead_free.html) for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to <https://www.diodes.com/quality/product-compliance-definitions/>.
  5. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

## Marking Information



62S = Product Type Marking Code  
 YM = Date Code Marking  
 Y = Year (ex: E = 2017)  
 M = Month (ex: 9 = September)

### Date Code Key

| Year | 2016 | 2017 | 2018 | 2019 | 2020 | 2021 | 2022 |
|------|------|------|------|------|------|------|------|
| Code | D    | E    | F    | G    | H    | I    | J    |

| Month | Jan | Feb | Mar | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |
|-------|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| Code  | 1   | 2   | 3   | 4   | 5   | 6   | 7   | 8   | 9   | O   | N   | D   |

## Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic   | Symbol           | Q1 Value | Q2 Value | Unit |
|--|------------------|----------|----------|------|
| Drain-Source Voltage   | V <sub>DSS</sub> | 60       | -50      | V    |
| Gate-Source Voltage  | V <sub>GSS</sub> | ±20      | ±20      | V    |
| Continuous Drain Current (Note 7)<br>N-Channel: V <sub>GS</sub> = 10V<br>P-Channel: V <sub>GS</sub> = -10V | I <sub>D</sub>   | 571      | -304     | mA   |
| Steady State<br>T <sub>A</sub> = +25°C<br>T <sub>A</sub> = +70°C   |                  | 457      | -243     |      |
| Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)   | I <sub>DM</sub>  | 1,200    | -800     | mA   |
| Maximum Body Diode Continuous Current (Note 7)   | I <sub>S</sub>   | 500      | -300     | mA   |

## Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic                                   | Symbol                            | Value       | Unit |
|--|-----------------------------------|-------------|------|
| Total Power Dissipation (Note 6)                 | P <sub>D</sub>                    | 0.51        | W    |
| Thermal Resistance, Junction to Ambient (Note 6) | R <sub>θJA</sub>                  | 250         | °C/W |
| Total Power Dissipation (Note 7)                 | P <sub>D</sub>                    | 0.84        | W    |
| Thermal Resistance, Junction to Ambient (Note 7) | R <sub>θJA</sub>                  | 150         | °C/W |
| Operating and Storage Temperature Range          | T <sub>J</sub> , T <sub>STG</sub> | -55 to +150 | °C   |

Notes: 6. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.  
 7. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

**Electrical Characteristics - Q1 N-CHANNEL** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic                          | Symbol              | Min | Typ  | Max | Unit | Test Condition  |
|---|---------------------|-----|------|-----|------|---|
| <b>OFF CHARACTERISTICS (Note 8)</b>     |                     |     |      |     |      |   |
| Drain-Source Breakdown Voltage          | BV <sub>DSS</sub>   | 60  | —    | —   | V    | V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA  |
| Zero Gate Voltage Drain Current         | I <sub>DSS</sub>    | —   | —    | 1   | μA   | V <sub>DS</sub> = 60V, V <sub>GS</sub> = 0V   |
| Gate-Source Leakage                     | I <sub>GSS</sub>    | —   | —    | ±10 | μA   | V <sub>GS</sub> = ±20V, V <sub>DS</sub> = 0V  |
| <b>ON CHARACTERISTICS (Note 8)</b>      |                     |     |      |     |      |   |
| Gate Threshold Voltage                  | V <sub>GS(TH)</sub> | 1.0 | —    | 2.5 | V    | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA                                    |
| Static Drain-Source On-Resistance       | R <sub>DS(ON)</sub> | —   | —    | 1.7 | Ω    | V <sub>GS</sub> = 10V, I <sub>D</sub> = 500mA   |
|   |                     | —   | —    | 3   |      | V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 200mA  |
| Diode Forward Voltage                   | V <sub>SD</sub>     | —   | —    | 1.4 | V    | V <sub>GS</sub> = 0V, I <sub>S</sub> = 115mA  |
| <b>DYNAMIC CHARACTERISTICS (Note 9)</b> |                     |     |      |     |      |   |
| Input Capacitance                       | C <sub>iss</sub>    | —   | 30   | —   | pF   | V <sub>DS</sub> = 25V, V <sub>GS</sub> = 0V,<br>f = 1.0MHz                                    |
| Output Capacitance                      | C <sub>oss</sub>    | —   | 4.2  | —   | pF   |   |
| Reverse Transfer Capacitance            | C <sub>rss</sub>    | —   | 2.9  | —   | pF   |   |
| Total Gate Charge                       | Q <sub>g</sub>      | —   | 0.4  | —   | nC   | V <sub>GS</sub> = 4.5V, V <sub>DS</sub> = 10V,<br>I <sub>D</sub> = 250mA                      |
| Gate-Source Charge                      | Q <sub>gs</sub>     | —   | 0.15 | —   | nC   |   |
| Gate-Drain Charge                       | Q <sub>gd</sub>     | —   | 0.09 | —   | nC   |   |
| Turn-On Delay Time                      | t <sub>D(ON)</sub>  | —   | 4.3  | —   | ns   | V <sub>DD</sub> = 30V, V <sub>GS</sub> = 10V,<br>R <sub>g</sub> = 25Ω, I <sub>D</sub> = 200mA |
| Turn-On Rise Time                       | t <sub>R</sub>      | —   | 2.7  | —   | ns   |   |
| Turn-Off Delay Time                     | t <sub>D(OFF)</sub> | —   | 15.1 | —   | ns   |   |
| Turn-Off Fall Time                      | t <sub>F</sub>      | —   | 6.5  | —   | ns   |   |

**Electrical Characteristics - Q2 P-CHANNEL** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic                          | Symbol              | Min | Typ  | Max  | Unit | Test Condition   |
|---|---------------------|-----|------|------|------|--|
| <b>OFF CHARACTERISTICS (Note 8)</b>     |                     |     |      |      |      |  |
| Drain-Source Breakdown Voltage          | BV <sub>DSS</sub>   | -50 | —    | —    | V    | V <sub>GS</sub> = 0V, I <sub>D</sub> = -250μA  |
| Zero Gate Voltage Drain Current         | I <sub>DSS</sub>    | —   | —    | -1   | μA   | V <sub>DS</sub> = -50V, V <sub>GS</sub> = 0V   |
| Gate-Source Leakage                     | I <sub>GSS</sub>    | —   | —    | ±10  | μA   | V <sub>GS</sub> = ±16V, V <sub>DS</sub> = 0V   |
| <b>ON CHARACTERISTICS (Note 8)</b>      |                     |     |      |      |      |  |
| Gate Threshold Voltage                  | V <sub>GS(TH)</sub> | -1  | —    | -2.5 | V    | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = -250μA                                      |
| Static Drain-Source On-Resistance       | R <sub>DS(ON)</sub> | —   | —    | 6    | Ω    | V <sub>GS</sub> = -10V, I <sub>D</sub> = -500mA  |
|   |                     | —   | —    | 8    |      | V <sub>GS</sub> = -5V, I <sub>D</sub> = -200mA   |
| Diode Forward Voltage                   | V <sub>SD</sub>     | —   | —    | -1.4 | V    | V <sub>GS</sub> = 0V, I <sub>S</sub> = -115mA  |
| <b>DYNAMIC CHARACTERISTICS (Note 9)</b> |                     |     |      |      |      |  |
| Input Capacitance                       | C <sub>iss</sub>    | —   | 26   | —    | pF   | V <sub>DS</sub> = -25V, V <sub>GS</sub> = 0V,<br>f = 1.0MHz                                      |
| Output Capacitance                      | C <sub>oss</sub>    | —   | 4.2  | —    | pF   |  |
| Reverse Transfer Capacitance            | C <sub>rss</sub>    | —   | 2.4  | —    | pF   |  |
| Total Gate Charge                       | Q <sub>g</sub>      | —   | 0.3  | —    | nC   | V <sub>GS</sub> = -4.5V, V <sub>DS</sub> = -10V,<br>I <sub>D</sub> = -500mA                      |
| Gate-Source Charge                      | Q <sub>gs</sub>     | —   | 0.14 | —    | nC   |  |
| Gate-Drain Charge                       | Q <sub>gd</sub>     | —   | 0.12 | —    | nC   |  |
| Turn-On Delay Time                      | t <sub>D(ON)</sub>  | —   | 4.1  | —    | ns   | V <sub>DD</sub> = -30V, V <sub>GS</sub> = -10V,<br>R <sub>g</sub> = 50Ω, I <sub>D</sub> = -270mA |
| Turn-On Rise Time                       | t <sub>R</sub>      | —   | 2.8  | —    | ns   |  |
| Turn-Off Delay Time                     | t <sub>D(OFF)</sub> | —   | 20.2 | —    | ns   |  |
| Turn-Off Fall Time                      | t <sub>F</sub>      | —   | 9.15 | —    | ns   |  |

Notes: 8. Short duration pulse test used to minimize self-heating effect.  
9. Guaranteed by design. Not subject to product testing.

**Typical Characteristics - N-CHANNEL**

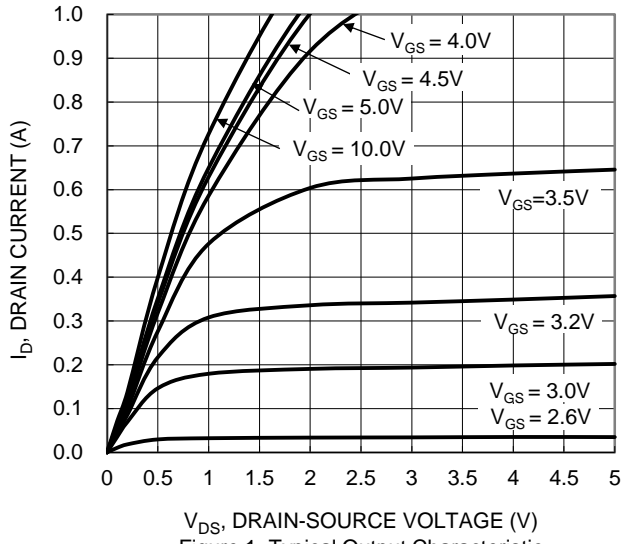


Figure 1. Typical Output Characteristic

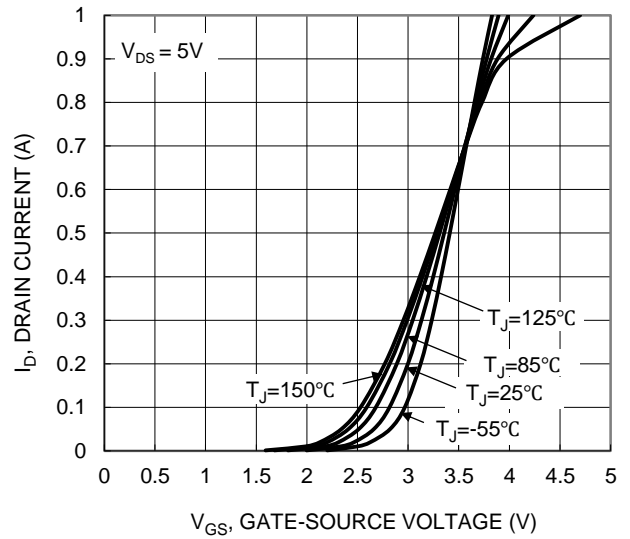


Figure 2. Typical Transfer Characteristic

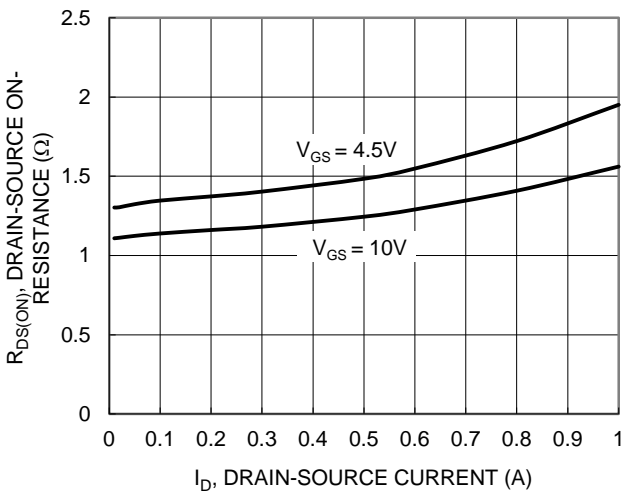


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

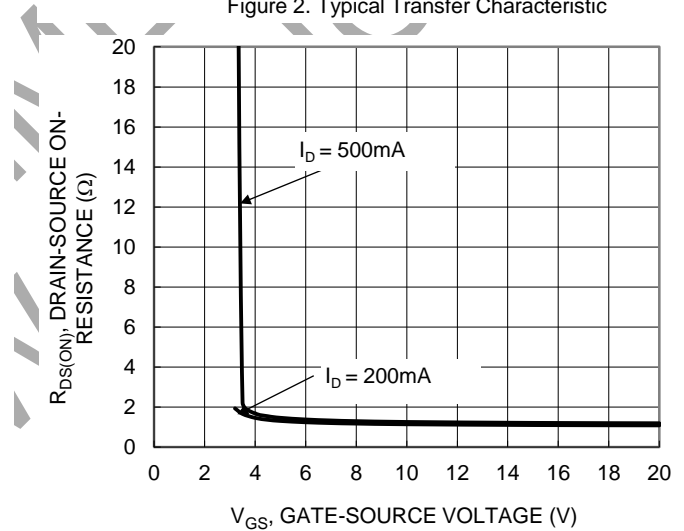


Figure 4. Typical Transfer Characteristic

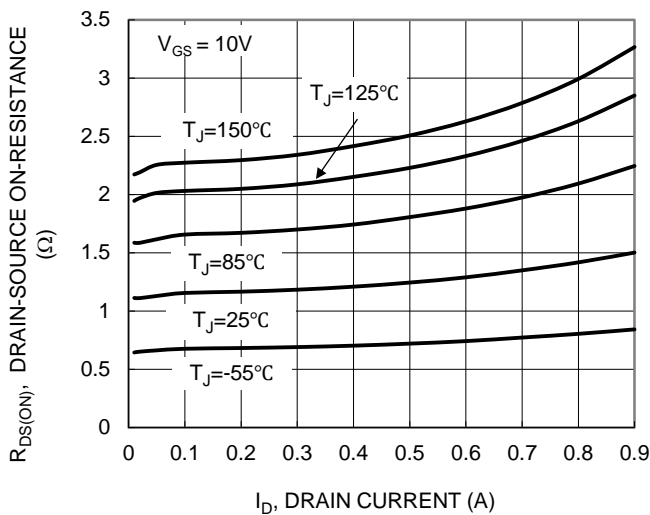


Figure 5. Typical On-Resistance vs. Drain Current and Temperature

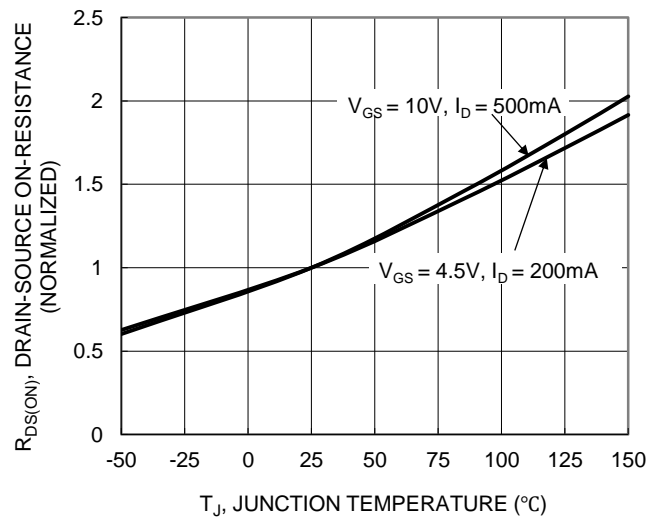


Figure 6. On-Resistance Variation with Temperature

**Typical Characteristics - N-CHANNEL (Cont.)**

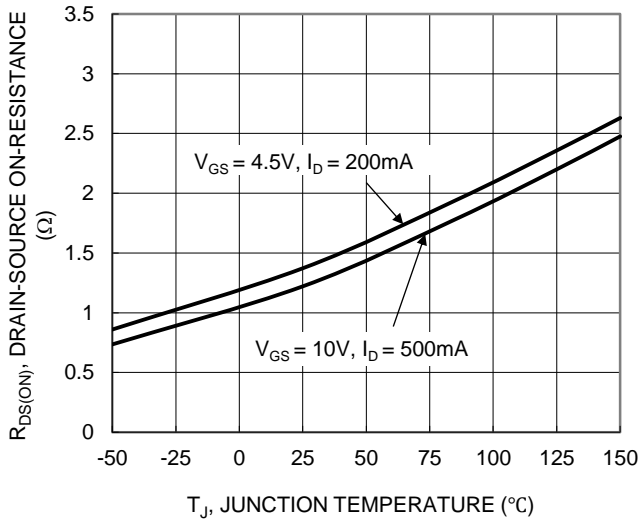


Figure 7. On-Resistance Variation with Temperature

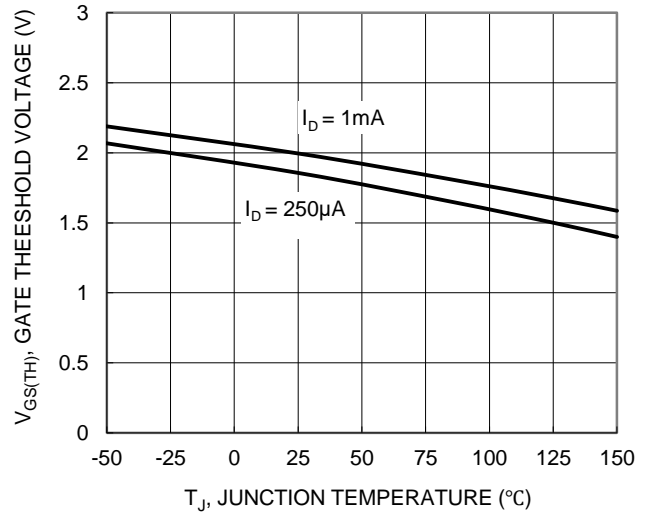


Figure 8. Gate Threshold Variation and Junction Temperature

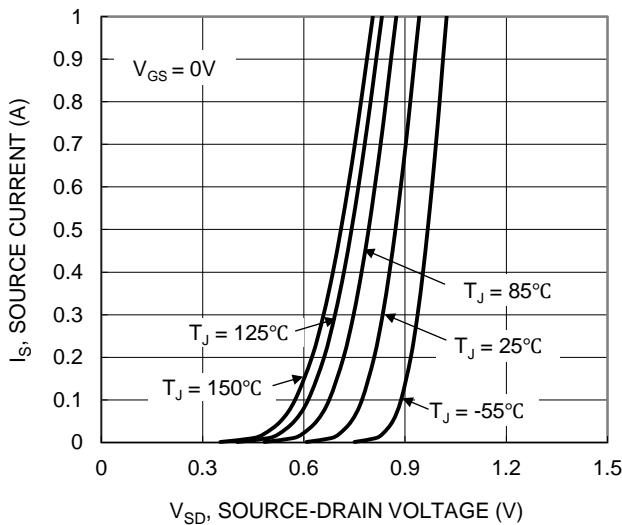


Figure 9. Diode Forward Voltage vs. Current

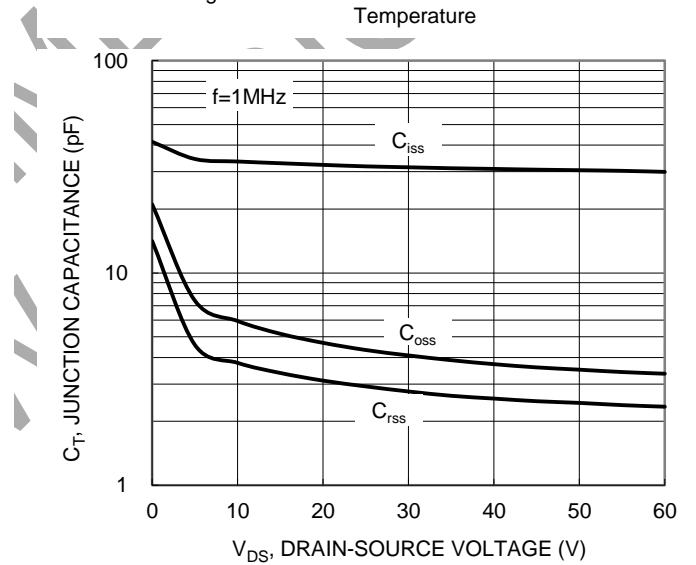


Figure 10. Typical Junction Capacitance

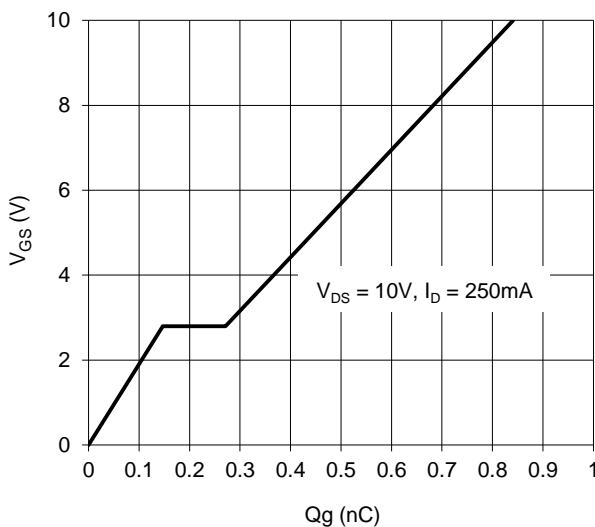


Figure 11. Gate Charge

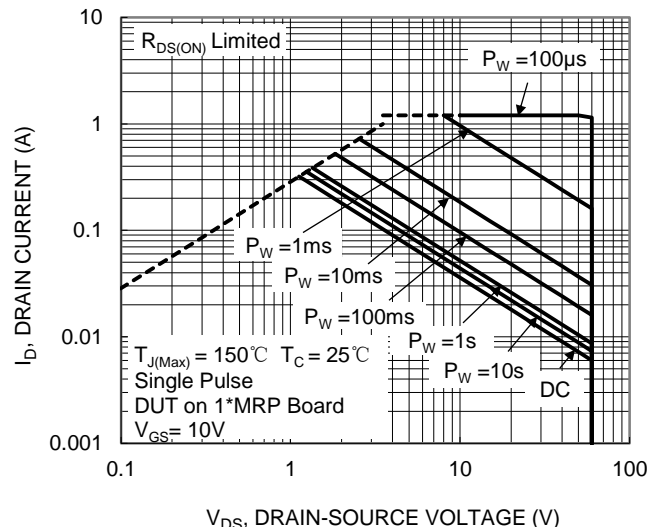


Figure 12. SOA, Safe Operation Area

**Typical Characteristics - P-CHANNEL**

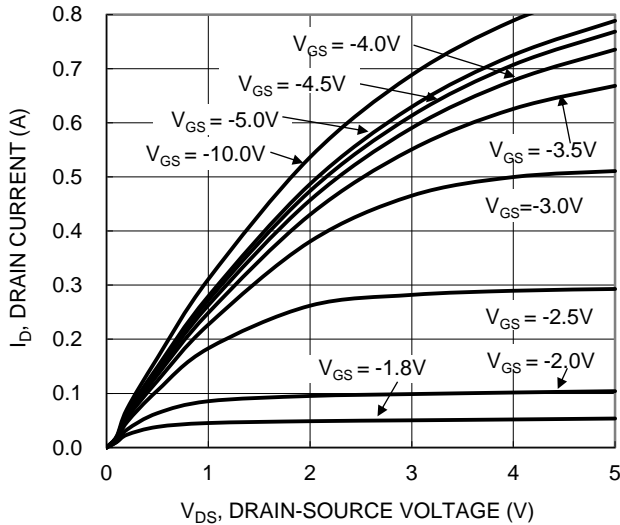


Figure 13. Typical Output Characteristic

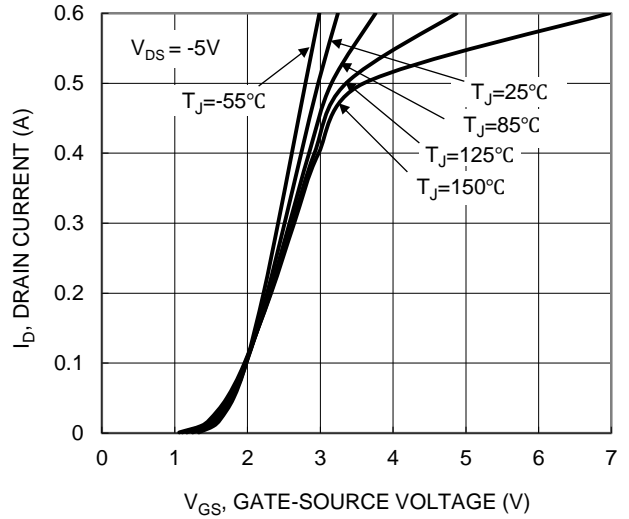


Figure 14. Typical Transfer Characteristic

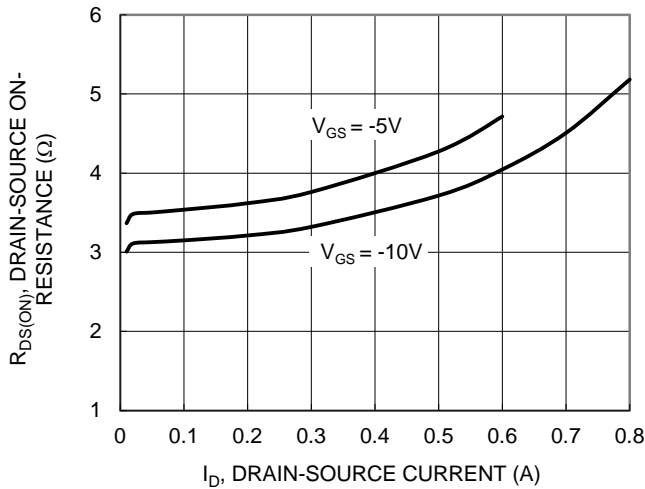


Figure 15. Typical On-Resistance vs. Drain Current and Gate Voltage

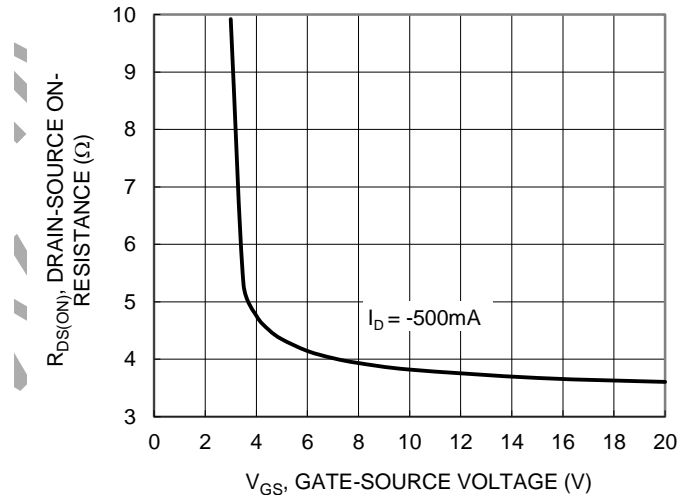


Figure 16. Typical Transfer Characteristic

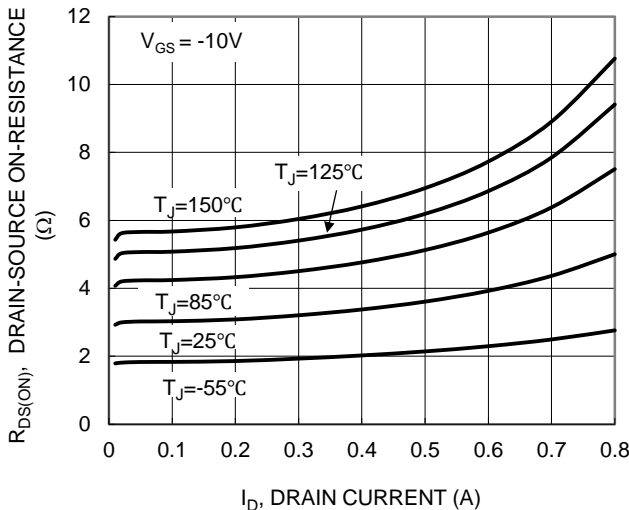


Figure 17. Typical On-Resistance vs. Drain Current and Temperature

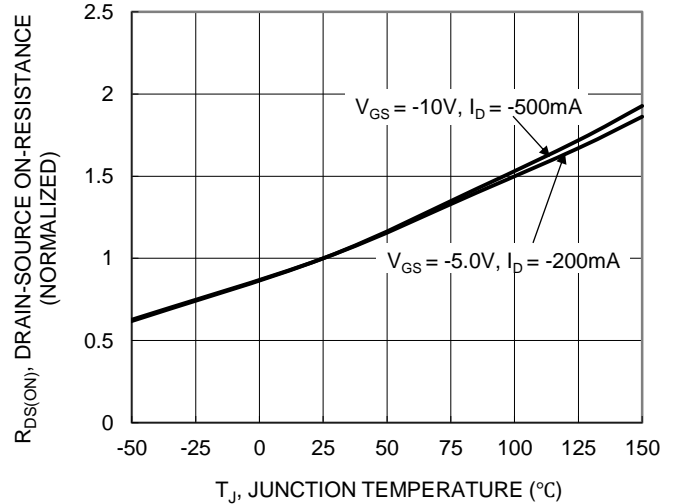


Figure 18. On-Resistance Variation with Temperature

**Typical Characteristics - P-CHANNEL (Cont.)**

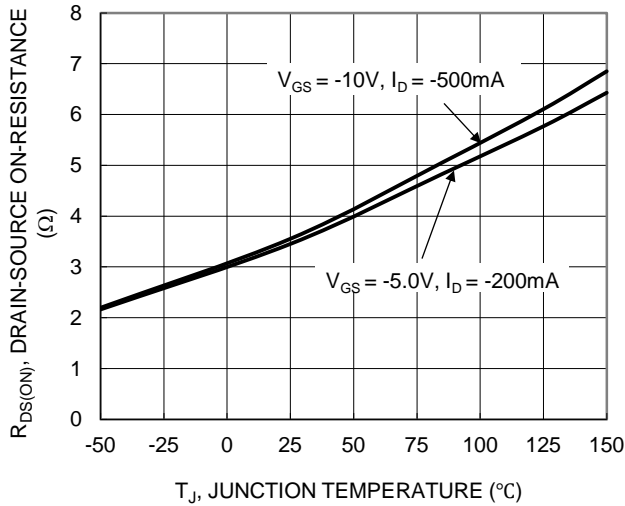


Figure 19. On-Resistance Variation with Temperature

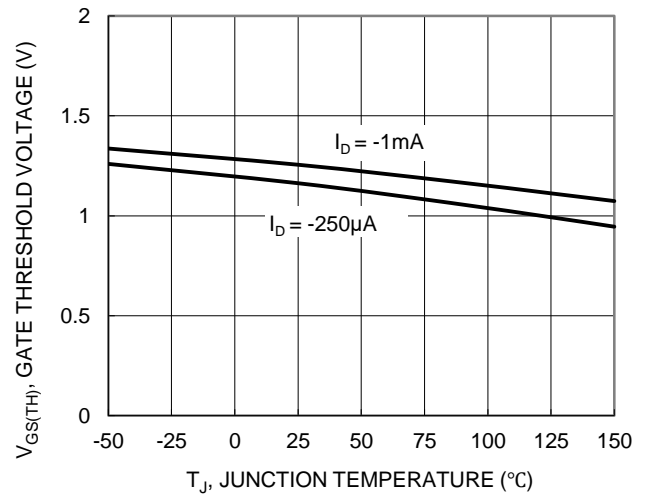


Figure 20. Gate Threshold Variation vs. Junction Temperature

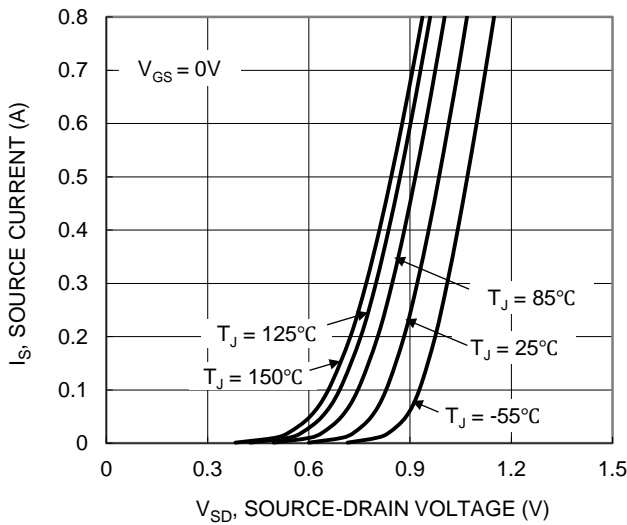


Figure 21. Diode Forward Voltage vs. Current

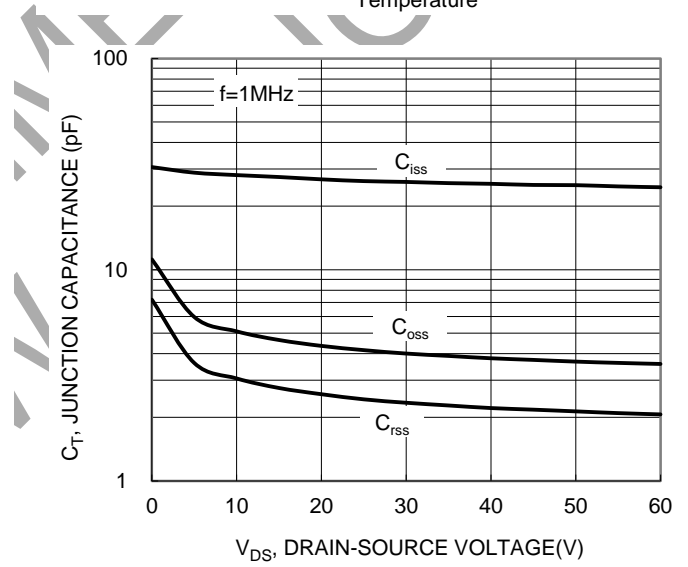


Figure 22. Typical Junction Capacitance

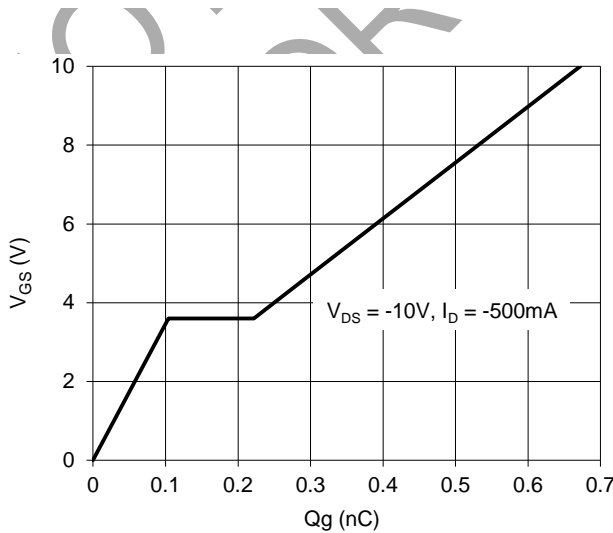


Figure 23. Gate Charge

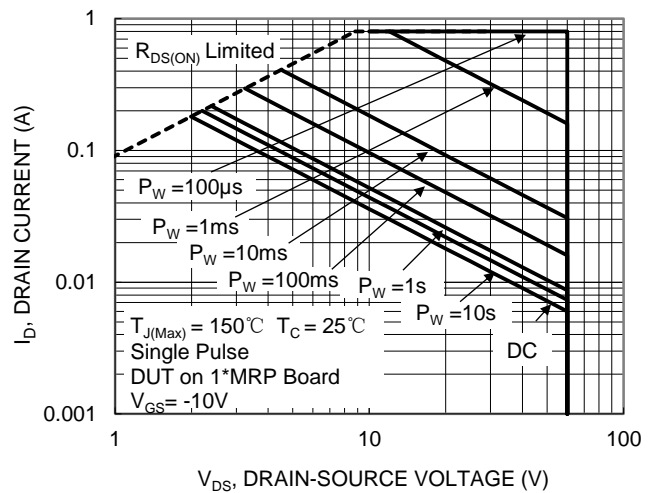


Figure 24. SOA, Safe Operation Area

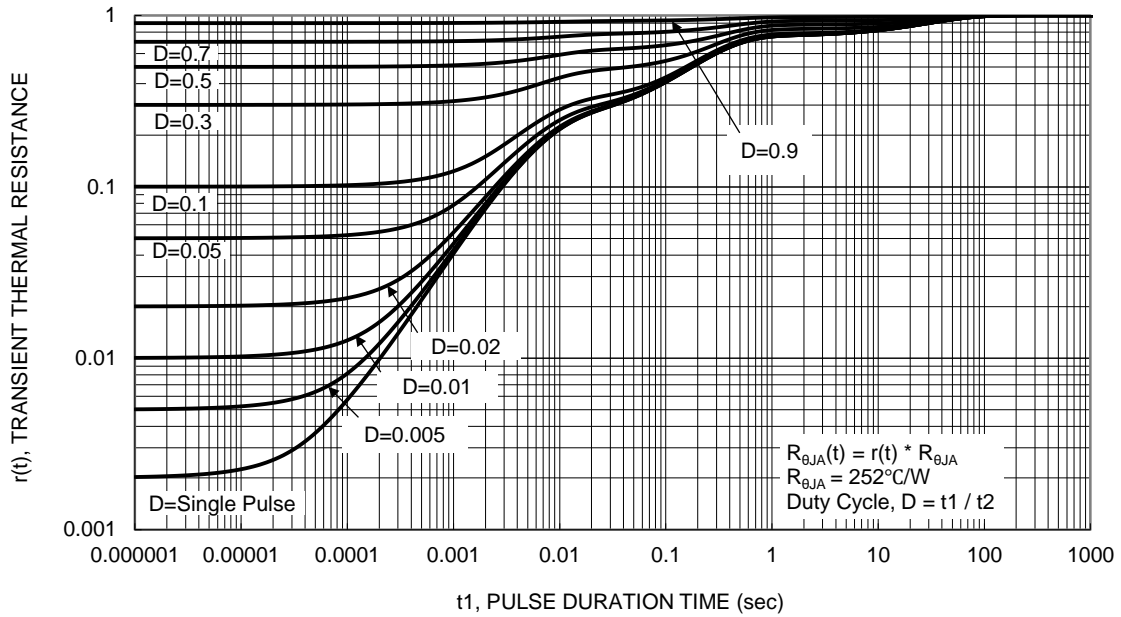


Figure 25. Transient Thermal Resistance

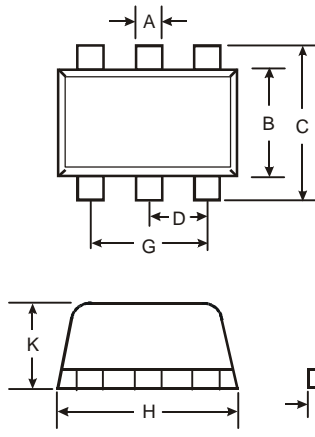
NOT RECOMMENDED FOR NEW DESIGN



## Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT563

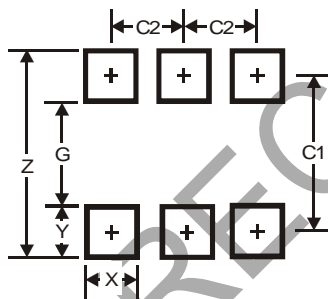


| SOT563               |      |      |      |
|----------------------|------|------|------|
| Dim                  | Min  | Max  | Typ  |
| A                    | 0.15 | 0.30 | 0.20 |
| B                    | 1.10 | 1.25 | 1.20 |
| C                    | 1.55 | 1.70 | 1.60 |
| D                    | -    | -    | 0.50 |
| G                    | 0.90 | 1.10 | 1.00 |
| H                    | 1.50 | 1.70 | 1.60 |
| K                    | 0.55 | 0.60 | 0.60 |
| L                    | 0.10 | 0.30 | 0.20 |
| M                    | 0.10 | 0.18 | 0.11 |
| All Dimensions in mm |      |      |      |

## Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT563



| Dimensions | SOT563 |
|------------|--------|
| Z          | 2.2    |
| G          | 1.2    |
| X          | 0.375  |
| Y          | 0.5    |
| C1         | 1.7    |
| C2         | 0.5    |

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